Dual Matched General Purpose Transistor

NPN Matched Pair

These transistors are housed in an ultra-small SOT-363 package ideally suited for portable products. They are assembled to create a pair of devices highly matched in all parameters, eliminating the need for costly trimming. Applications are Current Mirrors; Differential, Sense and Balanced Amplifiers; Mixers; Detectors and Limiters. Complementary PNP equivalent NST65010MW6T1G is available.

Features

- Current Gain Matching to 10%
- Base–Emitter Voltage Matched to 2 mV
- Drop-In Replacement for Standard Device
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	65	V
Collector-Base Voltage	V _{CBO}	80	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current – Continuous	Ι _C	100	mAdc

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Dissipation Per Device FR-5 Board (Note 1) $T_{\Delta} = 25^{\circ}C$	PD	380 250	mW
Derate Above 25°C		3.0	mW/°C
Thermal Resistance, Junction to Ambient	R_{\thetaJA}	328	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

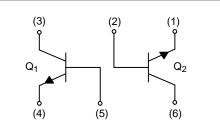
1. FR-5 = 1.0 x 0.75 x 0.062 in



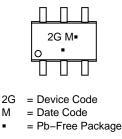
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MARKING DIAGRAMS



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NST65011MW6T1G	SOT-363 (Pb-Free)	3,000 / Tape & Reel
NSVT65011MW6T1G	SOT-363 (Pb-Free)	3,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage, (I _C = 10 mA)	V _{(BR)CEO}	65	-	-	V
Collector – Emitter Breakdown Voltage, ($I_C = 10 \ \mu A$, $V_{EB} = 0$)	V _{(BR)CES}	80	-	-	V
Collector – Base Breakdown Voltage, ($I_C = 10 \ \mu A$)	V _{(BR)CBO}	80	_	-	V
Emitter-Base Breakdown Voltage, ($I_E = 1.0 \ \mu A$)	V _{(BR)EBO}	6.0	_	_	V
Collector Cutoff Current $(V_{CB} = 30 \text{ V})$ $(V_{CB} = 30 \text{ V}, T_A = 150^{\circ}\text{C})$	I _{CBO}	_	_	15 5.0	nA μA

ON CHARACTERISTICS

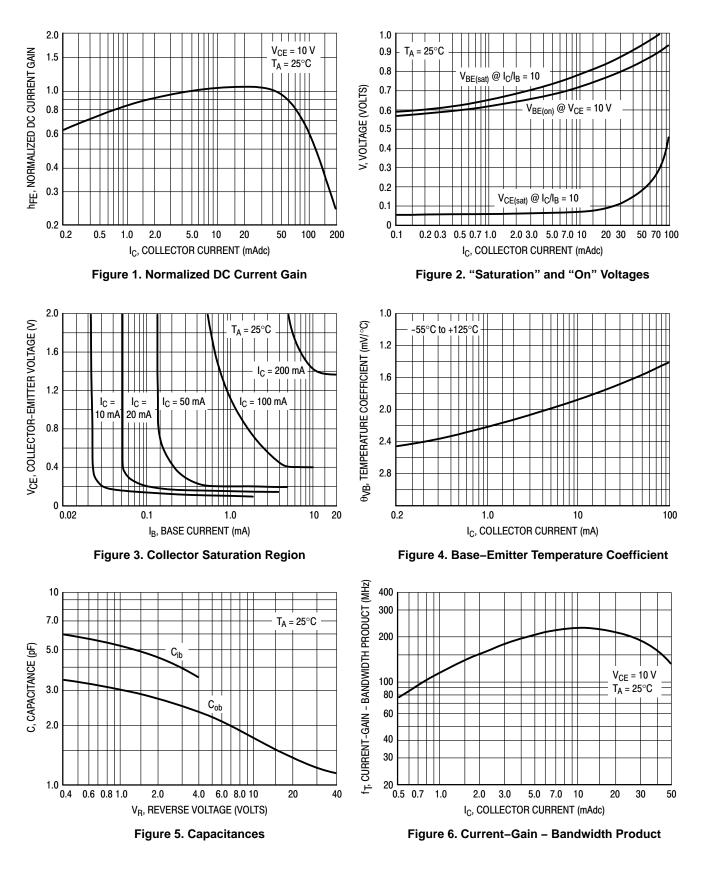
$ \begin{array}{l} \text{DC Current Gain} \\ (I_C = 10 \ \mu\text{A}, \ V_{CE} = 5.0 \ \text{V}) \\ (I_C = 2.0 \ \text{mA}, \ V_{CE} = 5.0 \ \text{V}) \\ (I_C = 2.0 \ \text{mA}, \ V_{CE} = 5.0 \ \text{V}) \ (\text{Note 2}) \end{array} $	h _{FE} h _{FE(1)} /h _{FE(2)}	150 200 0.9	_ 300 1.0	_ 500 1.1	_
Collector – Emitter Saturation Voltage ($I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$) ($I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$)	V _{CE(sat)}			250 600	mV
Base – Emitter Saturation Voltage $(I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA})$ $(I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA})$	V _{BE(sat)}	700 850	750 890	800 950	mV
$ \begin{array}{l} \text{Base} - \text{Emitter On Voltage} \\ (I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}) \\ (I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}) \\ (I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}) \text{ (Note 3)} \end{array} $	V _{BE(on)} V _{BE(1) -} V _{BE(2)}	580 - -	660 _ 1.0	700 770 2.0	mV

SMALL-SIGNAL CHARACTERISTICS

Current-Gain – Bandwidth Product, (I_C = 10 mA, V_{CE} = 5 Vdc, f = 100 MHz)	f _T	100	-	-	MHz
Output Capacitance, (V _{CB} = 10 V, f = 1.0 MHz)	C _{ob}	-	-	4.5	pF
Noise Figure, (I _C = 0.2 mA, V _{CE} = 5 Vdc, R _S = 2 k Ω , f = 1 kHz, BW = 200Hz)	NF	_	-	10	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. $h_{FE(1)}/h_{FE(2)}$ is the ratio of one transistor compared to the other transistor within the same package. The smaller h_{FE} is used as numerator. 3. $V_{BE(1)} - V_{BE(2)}$ is the absolute difference of one transistor compared to the other transistor within the same package.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

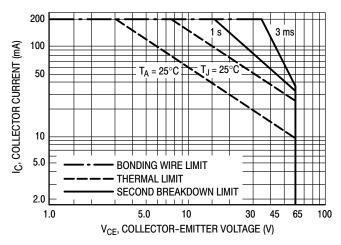


Figure 7. Active Region Safe Operating Area

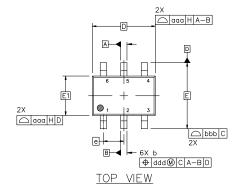
The safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 7 is based upon $T_{J(pk)} = 150^{\circ}$ C; T_C or T_A is variable depending upon conditions.

SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 **ISSUE Z**

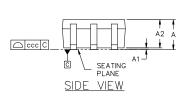
DATE 18 APR 2024

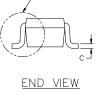
DUSEM



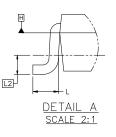
NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME 1. Y14.5-2018.
- 2.
- ALL DIMENSION ARE IN MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 3. PER END.
- 4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF DATUMS A AND B ARE DETERMINED AT DATUM H.
- 5.
- DIMENSIONS & AND C APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. 6.
- 7 ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION & AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

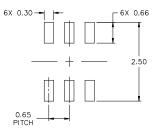




DETAIL A



	MILLIMETERS				
DIM	MIN.	NOM.	MAX.		
A			1.10		
A1	0.00		0.10		
A2	0.70	0.90	1.00		
b	0.15	0.20	0.25		
с	0.08	0.15	0.22		
D	2.00 BSC				
E	2.10 BSC				
E1	1.25 BSC				
е		0.65 BSC)		
L	0.26	0.36	0.46		
L2		0.15 BSC			
aaa	0.15				
bbb	0.30				
ccc	0.10				
ddd		0.10			



RECOMMENDED MOUNTING FOOTPRINT*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

XXX = Specific Device Code = Date Code* Μ

GENERIC **MARKING DIAGRAM***

XXXM-

0

6

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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DATE 18 APR 2024

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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